## **Power Electronics**

## POWERSWITCH Semiconductor Relav / - Contactor PH 9260

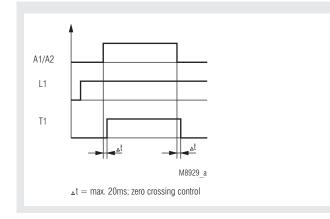




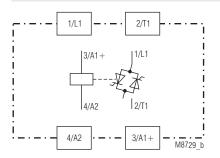


PH 9260.91

#### **Function Diagram**



#### **Circuit Diagram**



PH 9260.91

- AC semiconductor relay / -contactor •
- According to IEC/EN 60947-4-3
- Load current up to 125 A, AC 51 with  $l^2t$  up to 18000  $A^2s$ .
- Switching at zero crossing
- As option switching at voltage maximum .
- 2 anti-parallel thyristors
- DCB technology (direct bonding method) for excellent heat transmission properties
- Touch protection IP20
- Box terminals
- LED status indicator
- Peak reverse voltage 1200 V or 1600 V
- Insulation voltage 4000 V .
- As option with overtemperature protection
- As option with reduced HF-emission
- As option with heat sink, for DIN rail mounting
- Width: 45 mm

## Approvals and Markings



#### Applications

#### Solid state relays switching at zero crossing:

For frequent no-wear and no-noise switching of

- heating systems
- motors
- valves
- lighting systems

The semiconductor relay switches at zero crossing and is suitable for many applications e.g. extrusion machines for plastic and rubber, packaging machines, solder lines, machines in food industry.

#### Solid state relays switching at voltage maximum:

he solid state relay PH 9260/020 switching at voltage maximum is suitable to switch transformers. The usual high inrush current does not occur.

#### Function

The semiconductor relay PH 9260 is designed whith 2 anti-parallel connected thyristors switching at zero crossing.

When connecting the control voltage the output of the semiconductor relay is activated at the next zero crossing of the sinusoidal voltage. When disconnecting the control voltage the output is switched off at the next zero crossing of the load courrent.

The LED shows the state of the control input.

As option the semiconductor relay is available with heatsink to be mounted on DIN rail. This provides optimum heat transmission.

#### Notes

#### **Overtemperature protection**

Optionally, the semiconductor relay has an overtemperature protection to monitor the temperature of the heat sink. To this end, a thermal release switch (NC contact) can be inserted into the respective pocket at the bottom of the semiconductor relay. As soon as the temperature of the heat sink exceeds for example 100°C, the thermal release switch. For thermal protection of the semiconductor relay, a thermal release switch of UCHIYA type UP62 - 100 can be installed.

#### **Technical Data**

#### Output

Load voltage AC [V]:

PH 9260:

PH 9260/020:

Frequency range [Hz]:

Load current [A], AC-51: PH 9260, PH 9260/020:

Load current [A], AC-56a: PH 9260/020:

Load limit integral I2t [A2s]:

Max. overload current [A]

t = 10 ms:

Periodic overload current

t = 1 s [A]:

Min. current [mA]: On-state voltage

at nominal current [V]:

Rate of rise of off-state voltage [V/µs]:

Rate of rise of current [A/µs

#### **Temperature Data**

Thermal resistance junction - housing [K/W]:

Thermal resistance housing - ambient [K/W]:

Junction temperature [°C]:

	100 240, 200 480						
	47 63						
	25	50	100 <sup>1)</sup>	125 <sup>1)</sup>			
	10 -	20 30 <sup>3)</sup>	-	-			
:	800	1800 6600 <sup>2)</sup>	6600	18000			
	400	600 1150 <sup>2</sup>	1150	1900			
	40	120 150 <sup>2)</sup>	150	200			
		2	0				
	1.2	1.4	1.4	1.3			
	500	500	1000	1000			
ιs]:	100	100	100	150			
	0.6	0.5	0.3	0.3			
	12	12	12	12			

≤ 125

24 ... 240, 48 ... 480, 48 ... 600

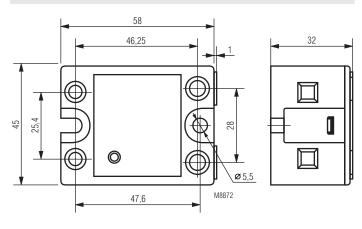
## Technical Data

Technical Data				
Degree of protection				
Housing:	IP 40	IEC/EN 60 529		
Terminals:	IP 20	IEC/EN 60 529		
Vibration resistance:	Amplitude 0.35 mm			
	frequency 10 55 Hz,	IEC/EN 60-068-2-0		
Housing material:		ed polycarbonate		
-	Flame resistant: UL 94			
Base plate:	Aluminum, copper nic	kle-plated		
Potting compound:	Polyurethane			
Mounting screws:	M5 x 8 mm			
Mounting torque:	2.5 Nm			
Connections control circuit:	Mounting screws M3 I	Pozidrive 2 PT		
Mounting torque:	0.5 Nm			
Wire cross section:	1.5 mm <sup>2</sup> wire			
Connections load circuit:	Mounting screws M4 F	ozidrive 1 PT		
Mounting torque:	1.2 Nm			
Wire cross section:	10 mm <sup>2</sup> wire			
Nominal insulation voltage				
Control circuit – load circuit:	4 kV <sub>eff.</sub>			
Load circuit – base plate:	4 kV <sub>eff.</sub>			
Overvoltage category:				
Weight				
without heat sink:	approx. 120 g			
PH 9260.91/ /01:	approx. 550 g			
PH 9260.91/ /02:	approx. 670 g			
Dimensions				
Width x height x depth				
without heat sink:	45 x 58 x 32 mm			
PH 9260.91/ /01:	45 x 80 x 124 mm			
PH 9260.91//02:	45 x 100 x 124 mm			
UL-Data				
Control voltage:	DC 4 32 V, Class 2 current / voltage limitir			
Load type:	Resistive			
<b>Wire connection:</b> 3A1+ / 4A2: 1L1 / 2T1:	Copper conductors or AWG 18 - 14 Torque 0 AWG 16 - 8 Torque 1.3	).5 Nm		



Technical data that is not stated in the UL-Data, can be found in the technical data section.

## Dimensions



## Accessories

PH 9260-0-12:

Graphite foil 55 x 40 x 0.25 mm to be fitted between device and heat sink, for better heat transmission Article number: 0058395

For the 100 A- and 125 A-variants we recommend a 25  $\rm mm^2$  adapter terminal type 802/115S, Brand FTG.

# <sup>1)</sup> Only for pulse operation: Please make sure, that the mean value of the current does not exceed 50 A on these devices.

2) Variant PH 9260.91/1\_\_

<sup>3)</sup> Variant PH 9260.91/120

## Control Circuit

	DC	AC/DC	AC/DC
Control voltage range [V]:	4 32	18 36	100 240
Max. nominal input current [mA]:	12	25 (AC)	5 bei
PH 9260:		12 (DC)	240 V AC
			(regulated)
Max. nominal input current [mA]: PH 9260/020:	20	-	-
Turn-on delay [ms]:	5 + 1/2 c	ycle	
Turn-off delay [ms]			
at AC/DC 1836 V:	20 + 1/2	cycle	
at AC/DC 85 265 V:	30 + 1/2	cycle	
General Data			

Operating mode:	Continuous operation	1
Temperature range: operation:	- 20 40° C	
storage:	- 20 80° C	
Clearance and creepage		
distances		
rated impulse voltage /		
pollution degree:	6 kV / 3	IEC/EN 60 664-1
EMC:	IEC/EN 61 000-6-4,	IEC/EN 61 000-4-1
Electrostatic discharge (ESD):	8 kV air / 6 kV contact	IEC/EN 61 000-4-2
HF irradiation:	10 V / m	IEC/EN 61 000-4-3
Fast transients:	2 kV	IEC/EN 61 000-4-4
Surge voltages		
between		
wires for power supply:	1 kV	IEC/EN 61 000-4-5
between wire and ground:	2 kV	IEC/EN 61 000-4-5
HF-wire guided	10 V	IEC/EN 61 000-4-6
Interference suppression:	Limit value class A	IEC/EN 60 947-4-3

#### **Technical Data**

#### Contents of Article Numbers

Type PH 9260									
	/ariant signation)	Standard	PH 9260/000/01 with heat sink	Standard	PH 9260/000/02 with heat sink	PH 9260/100 (I²t = 6600 A²s)	PH 9260/100/02 (I <sup>2</sup> t = 6600 A²s with heat sink)	Standard	Standard
Loa	d current	25 A	25 A	50 A	50 A <sup>3)</sup>	50 A	50 A <sup>3)</sup>	100 A	125 A
Load voltage	Control voltage								
	4 32 V DC	0056651	0056953	0056652	0056954	0057699	0058195	0056821	0059736
24 240 V AC	18 36 V AC/DC	0063505	0063676	*	*	*	*	*	*
	100 240 V AC/DC	0061422	0058255	0059749	0058256	*	*	0059631	*
	4 32 V DC	0056653	0056955	0056654	0056956	0057700	0058196	0056822	0059737
48 480 V AC	18 36 V AC/DC	*	*	*	*	*	*	*	*
	100 240 V AC/DC	0059690	0061943	0059691	0059074	*	*	0063193	*
	4 32 V DC	0058676	*	*	0059980	0058678	*	0058677	*
48 600 V AC	18 36 V AC/DC	*	*	0058958	*	0058960	*	*	*
	100 240 V AC/DC	*	*	0058959	*	0058961	*	*	*

At devices without heatsink the necessary heatsink has to be chosen according to the dimensioning notes.

#### \* On request

Units with UL-Approval

 $^{\scriptscriptstyle 3)}$  for stepping operation with 80 % ED

#### Standard Type

 PH 9260.91
 AC 48 ... 480 V
 50 A
 DC 4 ... 32 V

 Article number:
 0056654

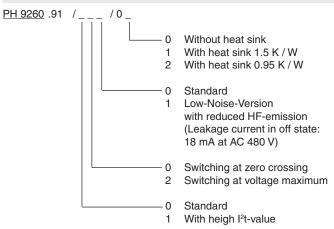
 • Load voltage:
 AC 48 ... 480 V

- Load current:
- Control voltage:

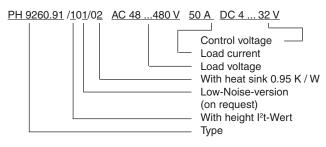
Width:

50 A DC 4 ... 32 V 45 mm

### Variantes



#### Ordering example for variants



#### Selection of a Heat Sink

Load current (A)		The	PH 926 ermal resi	0 25 A stance (K	/W)	
25.0	2.8	2.5	2.1	1.8	1.5	1.1
22.5	3.2	2.8	2.5	2.1	1.7	1.3
20.0	3.7	3.3	2.8	2.4	2.0	1.6
17.5	4.3	3.8	3.4	2.8	2.4	1.9
15.0	5.1	4.6	4.0	3.5	2.9	2.4
12.5	6.3	5.6	5.0	4.3	3.6	2.8
10.0	8.0	7.2	6.4	5.6	4.7	3.9
7.5	11.0	9.9	8.7	7.6	6.5	5.4
5.0	16.8	15.0	13.5	12.0	10.0	8.5
2.5	-	-	-	-	21.0	17.6
	20	30	40	50	60	70
	Ambient-temperature (°C)					

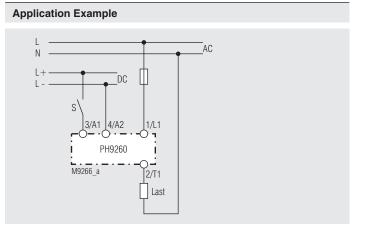
Load current (A)		The	PH 9260 ermal resis		/W)	
50	0.9	0.7	0.6	0.4	0.3	-
45	1.0	0.9	0.7	0.5	0.4	0.2
40	1.2	1.0	0.9	0.7	0.5	0.3
35	1.5	1.3	1.0	0.9	0.7	0.5
30	1.9	1.6	1.4	1.1	0.9	0.7
25	2.4	2.0	1.8	1.5	1.2	0.9
20	3.0	2.7	2.4	2.0	1.9	1.3
15	4.4	3.9	3.4	2.9	2.5	2.0
10	6.9	6.0	5.4	4.7	4.0	3.3
5	14.0	12.9	11.5	10.0	8.6	7.2
	20	30	40	50	60	70
	Ambient-temperature (°C)					

Notes on Sizing for Selection of a Heat Sink

The heat generated by the load current must be dissipated by a suitable heat sink. It is imperative that the junction temperature of the semiconductor is maintained for all potential environmental temperatures of under 125°C. For this reason, it is important to keep the thermal resistance between the base plate of the semiconductor relay and the heat sink to a minimum.

To protect the semiconductor relay effectively from excess heating, a thermally conducting paste should be applied before installation to the base plate of the heat sink between semiconductor relay and heat sink.

From the tables below, select a suitable heat sink with the next lowest thermal resistance. Thus, it is ensured that the maximum junction temperature of 125°C is not exceeded. The load current in relation to the environmental temperature can be seen from the table.



Load current (A)		The	PH 9260 ermal resi		/W)	
100	0.43	0.35	0.25	0.2	-	-
90	0.56	0.46	0.35	0.28	0.2	-
80	0.7	0.6	0.5	0.4	0.3	0.2
70	0.9	0.8	0.65	0.55	0.4	0.3
60	1.2	1.0	0.9	0.75	0.6	0.46
50	1.6	1.4	1.2	1.0	0.85	0.6
40	2.3	2.0	1.8	1.5	1.2	1.0
30	3.4	3.0	2.5	2.2	2.0	1.5
20	5.6	5.0	4.5	3.9	3.3	2.7
10	12.0	11.0	10.0	9.0	7.6	6.0
	20	30	40	50	60	70
	Ambient-temperature (°C)					

Load current (A)	PH 9260 125 A Thermal resistance (K/W)					
125	0.5	0.4	0.3	0.2	0.1	0.1
112.5	0.6	0.5	0.4	0.3	0.2	0.1
100	0.7	0.6	0.5	0.4	0.3	0.2
87.5	0.9	0.8	0.7	0.5	0.4	0.3
75	1.0	1.0	0.9	0.7	0.6	0.5
62.5	1.5	1.4	1.1	1.0	0.8	0.7
50	2.0	1.8	1.6	1.3	1.1	0.9
37.5	3.0	2.6	2.3	2.0	1.7	1.4
25	4.7	4.2	3.5	3.0	2.8	2.3
12.5	10.2	9.0	8.0	7.0	6.0	5.0
	20	30	40	50	60	70
	Ambient-temperature (°C )					

#### Installation Instructions

#### **General Information**

The service life and long-time reliability of a solid-state relay depends on its installation and use. Load type, load current, switching frequency, mains voltage and ambient temperature must be taken into account during the project design. To ensure the reliable operation of the devices, an exact analysis of the application and a calculation of the heat sink must be conducted in advance. Solid-state relays constantly produce heat during operation. The ambient conditions therefore require special attention. The choice of the correct heat sink is especially important since the constant overtemperature significantly reduces the service life of the devices. The use of a temperature switch is recommended if neither the load conditions nor the ambient temperatures are known. This switch is available as accessory and is inserted in a pocket on the bottom side.

Attention: The load output is not electrically separated from the mains even if no drive is present

#### **Overload protection (Fig. 1)**

The solid-state relay must be protected against short circuit by a separate solid-state fuse of coordination type 2. Choosing the I2t value (switch-off integral) of the fuse half as large as the I2t value of the semiconductor is recommended.

#### Overvoltage protection (Fig. 1)

Although the solid-state relays can withstand high peak voltages, it is better to switch an external varistor parallel to the load output. This is particularly recommended when switching inductive loads. The varistor voltage must be selected appropriate for the mains voltage. A wrong selection can create hazardous situations. As an option, the varistor is factory-installed.

#### Assembly on the heat sink (Fig. 2, Fig. 3)

A small amount of silicon-containing heat transfer compound is to be applied to the base plate to ensure a good thermal bond between solid-state relay and heat sink. As an alternative, a graphite foil can be placed between solid-state relay and heat sink.



#### Attention!

Heat transfer compounds without silicon should not be used, since they may attack the plastic of the housing .

The solid-state relay is mounted to the heat sink using two M5x8 screws and matching washers. Both screws should be tightened in alternating fashion until a torque of 1 Nm is reached. After approx. one hour the screws need to be tightened further with a final torque of 2.5 Nm. This ensures that all excess heat transfer compound is squeezed out or that the graphite foil can well adapt to the contours of the surfaces.

#### Installation of the complete unit (Fig. 4)

The fins of the heat sink must be aligned in a manner allowing the unobstructed circulation of air. Without external fan, the fins must be aligned vertically to support natural convection.

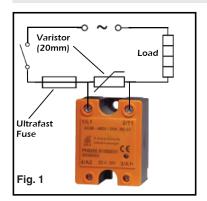
#### Connection

	Control terminals	Load terminals
Screw:	M3 Pozidrive	M4 Pozidrive
Tightening torque:	0,5 Nm	1,2 Nm
Wire gauge:	1,5 mm <sup>2</sup>	10 mm <sup>2</sup>



Attention! When using pneumatic or electric power screwdrivers, their torque limit must be set correctly.

#### Installation Instructions









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